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RENESAS SEMICONDUCTOR RELIABILITY REPORT

- GROUP : RL78/G22
- DEVICE : R7F102GXXX
- APPLICATION : Consumer / Industry

Quality Assurance Div. Renesas Electronics Corporation



MCR-23-0018-A

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Table. Reliability test results (QFP)

Test Items	Items Reference Test Conditions		Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 ℃ to 150 ℃ , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM) JS-001		1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

*1) With preconditioning per JESD22-A113, MSL 3 •It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :



Table. Reliability test results (QFN)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 ℃ to 150 ℃ , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM) JS-001 1.5 kΩ, 100 pF, +/-200		1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

*1) With preconditioning per JESD22-A113, MSL 3 •It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :



Table. Reliability test results (SOP)

Test Items	Items Reference Test Conditions		Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	JESD22-A104	Ta=-65 ℃ to 150 ℃ , 300 cycles	0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM) JS-001		1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Solderability (SD)	J-STD-002	245 ℃, 5 s, Solder coverage ≥95 %	0/5	
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

*1) With preconditioning per JESD22-A113, MSL 3 •It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :



Table. Reliability test results (LGA)

Test Items	Reference	Test Conditions	Results Failure/Size	Comment
High Temperature Operating Life (HTOL)	JESD22-A108	Ta=125 ℃, Vccmax, 1000 hrs	0/22	
High Temperature Storage Life (HTSL)	JESD22-A103	Ta=150 ℃, 1000 hrs	0/22	
Temperature Humidity bias (THB) (*1)	JESD22-A101	Ta=85 ℃, RH=85 %, Vccmax, 1000 hrs	0/22	
Temperature Cycling (TC) (*1)	1 = 1 = 1 = 1 = 1 = 1 = 1 = 1 = 1 = 1 =		0/22	
Latch-Up (LU)	JESD78	Pulse Current Injection, I=+/-150 mA	0/3	
Electrostatic discharge (ESD-HBM) JS-001		1.5 kΩ, 100 pF, +/-2000 V, 1 time	0/3	Class: 2
Electrostatic discharge (ESD-CDM)	JESD22-C101	+/-500V,1time	0/3	Class: C2
Resistance to Soldering Heat (PC)	JESD22-A113, J-STD-020	MSL3(Moisture Sensitivity Level 3)	0/22	

*1) With preconditioning per JESD22-A113, MSL 3 •It is tested to confirm that all the samples are satisfied with an individual product specification.

Note :



The failure rate of the device in an actual use condition can be estimated by the below procedure.

• Equation for the failure rate estimation (λ)

 $\lambda = \lambda b \times \pi T$ (FIT)

(1)Unique failure rate (λ b)

λb= 4.1 FIT

Unique failure rate at Ta=55 $^{\circ}$ C using 60 $^{\circ}$ confidence level.

②Temperature term (π T)

 π T=exp{11600×Ea×(1/(273+55)-1/(273+Ta))}

Ea: Activation energy (eV)

Ta : Ambient temperature ($^{\circ}$ C)

πTs	π T simplified chart as Ea=0.7 eV											
Ta (℃)	40	50	55	60	65	70	75	80	85	90	100	110
πΤ	0.31	0.68	1	1.45	2.08	2.95	4.15	5.77	7.96	10.88	19.82	34.99

•MTTF (Mean Time To Failure)

 $MTTF = 1/\lambda$



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Reference about Renesas package code

Package type	Package code *1	
Lead type plastic package	QFP	PxQP
	SOP	PxSP
Non-lead type plastic package	QFN	PxQN
Grid array type plastic package	BGA	PxBG
	LGA	PxLG

*1. First four digit

Table. Product list

		I	I_ · ·			- · ·	1
No	Group	Product part number	Package code	No	Group	Product part number	Package code
1	RL78/G22	R7F102GGC2DFB	PLQP0048K*	51			
2	RL78/G22	R7F102GGC3CFB	PLQP0048K*	52			
3	RL78/G22	R7F102GGE2DFB	PLQP0048K*	53			
4	RL78/G22	R7F102GGE3CFB	PLQP0048K*	54			
5	RL78/G22	R7F102GAC2DSP	PLSP0030J*	55			
6	RL78/G22	R7F102GAC3CSP	PLSP0030J*	56			
7	RL78/G22	R7F102GAE2DSP	PLSP0030J*	57			
8	RL78/G22	R7F102GAE3CSP	PLSP0030J*	58			
9	RL78/G22	R7F102GFC2DFP	PLQP0044G*	59			
10	RL78/G22	R7F102GFC3CFP	PLQP0044G*	60			
11	RL78/G22	R7F102GFE2DFP	PLQP0044G*	61			
12	RL78/G22	R7F102GFE3CFP	PLQP0044G*	62			
13	RL78/G22	R7F102GBC2DFP	PLQP0032G*	63			
14	RL78/G22	R7F102GBC3CFP	PLQP0032G*	64			
15	RL78/G22	R7F102GBE2DFP	PLQP0032G*	65			
16	RL78/G22	R7F102GBE3CFP	PLQP0032G*	66			
17	RL78/G22	R7F102G4C2DNP	PWQN0016K*	67			
18	RL78/G22	R7F102G4C3CNP	PWQN0016K*	68			
19	RL78/G22	R7F102G4E2DNP	PWQN0016K*	69			
20	RL78/G22	R7F102G4E3CNP	PWQN0016K*	70			
21	RL78/G22	R7F102G7C2DNP	PWQN0024K*	71			
22	RL78/G22	R7F102G7C3CNP	PWQN0024K*	72			
23	RL78/G22	R7F102G7E2DNP	PWQN0024K*	73			
24	RL78/G22	R7F102G7E3CNP	PWQN0024K*	74			
25	RL78/G22	R7F102GBC2DNP	PWQN0032K*	75			
26	RL78/G22	R7F102GBC3CNP	PWQN0032K*	76			
27	RL78/G22	R7F102GBE2DNP	PWQN0032K*	77			
28	RL78/G22	R7F102GBE3CNP	PWQN0032K*	78			
29	RL78/G22	R7F102GEC2DNP	PWQN0040K*	79			
30	RL78/G22	R7F102GEC3CNP	PWQN0040K*	80			
31	RL78/G22	R7F102GEE2DNP	PWQN0040K*	81			
32	RL78/G22	R7F102GEE3CNP	PWQN0040K*	82			
33	RL78/G22	R7F102GGC2DNP	PWQN0048K*	83			
34	RL78/G22	R7F102GGC3CNP	PWQN0048K*	84			
35	RL78/G22	R7F102GGE2DNP	PWQN0048K*	85			
36	RL78/G22	R7F102GGE3CNP	PWQN0048K*	86	1		1
37	RL78/G22	R7F102G8C2DLA	PWLG0025K*	87			
38	RL78/G22	R7F102G8C3CLA	PWLG0025K*	88			
39	RL78/G22	R7F102G8E2DLA	PWLG0025K*	89			
40	RL78/G22	R7F102G8E3CLA	PWLG0025K*	90			
41	RL78/G22	R7F102G6L5CLA	PWLG0025K*	90			
42	RL78/G22	R7F102GCC2DLA	PWLG0036K*	91			
42	RL78/G22	R7F102GCC3CLA	PWLG0036K*	92			
43	RL78/G22 RL78/G22	R7F102GCE2DLA	PWLG0036K*	93			
44 45	RL78/G22 RL78/G22	R7F102GCE3CLA R7F102G6C2DSP	PULG0030K*	94 95	1		+
		R7F102G6C2DSP R7F102G6C3CSP	PLSP0020J* PLSP0020J*				
46	RL78/G22			96 97			
47	RL78/G22	R7F102G6E2DSP	PLSP0020J*				
48	RL78/G22	R7F102G6E3CSP	PLSP0020J*	98			
49				99			
50				100			